

IN THE UNITED STATES PATENT & TRADEMARK OFFICE

IN RE APPLICATION OF:

Yoshiaki UEMATSU, et al.. : GROUP ART UNIT: Unknown

SERIAL NO: New Utility Application : EXAMINER: Unassigned

FILED: Herewith

FOR: A WIRING BOARD AND
A METHOD FOR
MANUFACTURING THE
WIRING BOARD

PRELIMINARY AMENDMENT

ASSISTANT COMMISSIONER FOR PATENTS
WASHINGTON, D.C. 20231

SIR:

Prior to examination on the merits, please amend the above-identified application, as follows, without prejudice:

IN THE CLAIMS

Please amend Claims 17 and 18 as shown in the Marked-Up Copy at the end of this Amendment. A clean copy Claims 17 and 18 is shown below:

17. (Amended) The wiring board according to claim 3,
wherein the base board includes an insulating layer,
wherein the insulating portion is filled with an insulator which has a higher dielectric constant than an insulator in the insulating layer.

18. (Amended) The wiring board according to claim 4,
wherein the base board includes an insulating layer,

wherein the insulating portion is filled with an insulator which has a higher dielectric constant than an insulator in the insulating layer.

REMARKS

Claim 18 has been corrected to move its number to the beginning of the claim and removing the number 18 from the end of Claim 17. As a result, Claims 1-20 are pending in the present Application.

In view of the foregoing, favorable consideration of this Amendment is felt to be in order and the same is hereby respectfully requested.

Respectfully submitted,

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Marked-Up Copy
Serial No: New Utility Application
Amendment Filed on:

IN THE CLAIMS:

Please amend claims 17 and 18, as follows:

17. (Amended) The wiring board according to claim 3,

wherein the base board includes an insulating layer,

wherein the insulating portion is filled with an insulator which has a higher dielectric constant than an insulator in the insulating layer.[18.]

18. (Amended) The wiring board according to claim 4,

wherein the base board includes an insulating layer,

wherein the insulating portion is filled with an insulator which has a higher dielectric constant than an insulator in the insulating layer.